

Tinker Board

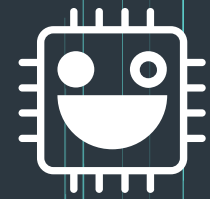
AIoT를 위한 최선의 엣지 단말기



MAKER SPACE
G·CAMP

Contents

- Tinker 소개
- Tinker 비교 가이드
- 산업 활용 예시
- 악세서리 소개










tinker board

Product Roadmap

● Product MP

● Next Gen new

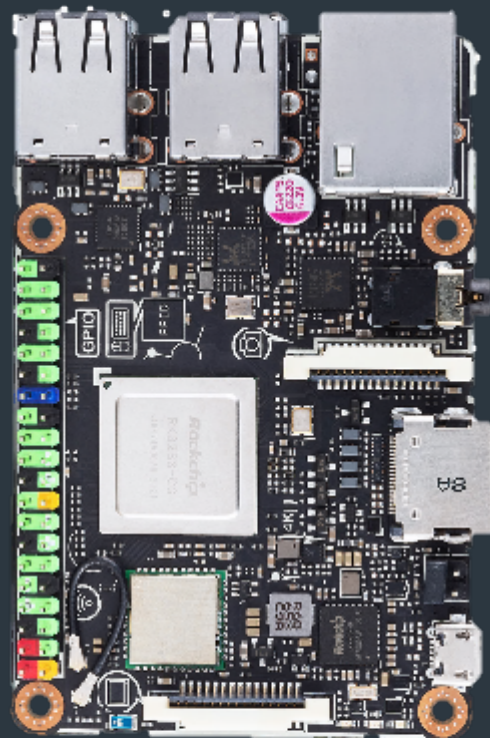
Q3'22	Q4'22	Q1'23	Q2 '23
Tinker Edge T 4 x Cortex-A53 @ 1.5GHz, edge TPU 1GB LPDDR4, 8GB eMMC 			
Tinker Edge R 2 x Cortex-A72 @ 1.8GHz + 4 x Cortex-A53 @ 1.4GHz, NPU 2+1/4+2GB LPDDR, 16GB eMMC 			
Tinker Board 2S 2 x Cortex-A72 @ 2.0GHz + 4 x Cortex-A53 @ 1.5GHz 2GB/4GB LPDDR4, 16GB eMMC 			
Tinker Board 2 2 x Cortex-A72 @ 2.0GHz + 4 x Cortex-A53 @ 1.5GHz 2GB/4GB LPDDR4 			
Tinker Board S R2.0 4 x Arm® Cortex®-A17 @ 1.8 GHz 2GB LPDDR3, 16/32GB eMMC 			
Tinker Board R2.0 4 x Arm® Cortex®-A17 @ 1.8 GHz 2GB LPDDR3 			
Tinker System 2 RK3399, Fanless, 2GB/4GB LPDDR4, 16/32GB eMMC Certified with RF Regulation 			

Tinker Board Series 소개

TINKER BOARD 2S



TINKER BOARD S R2.0



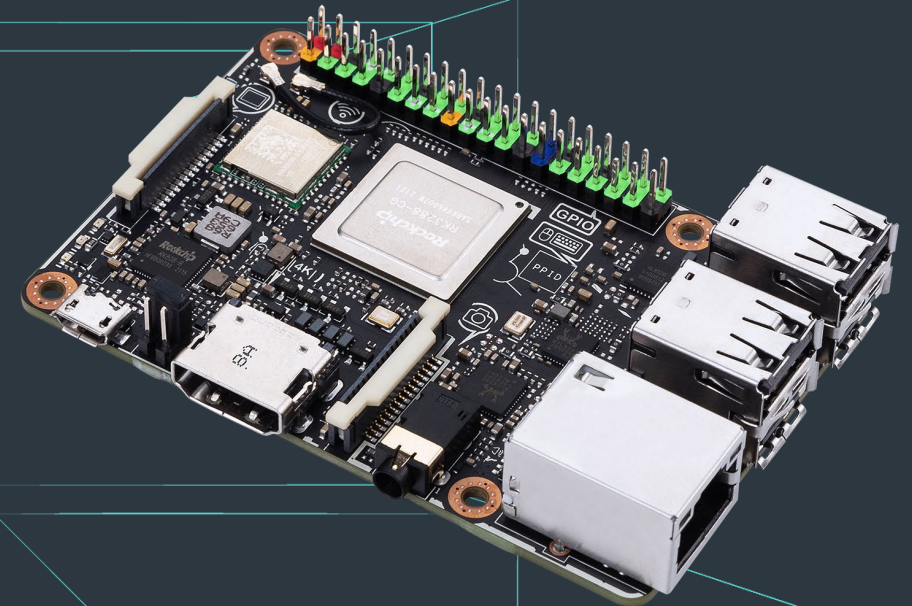
Microsoft
Azure
Certified

TINKER BOARD 3N Series



Tinker Board R2.0 series - 사양

	TINKER BOARD R2.0 / TINKER BOARD S R2.0
SoC	Rockchip RK3288-CG.W (32bit)
CPU	Quad-core ARM Cortex-A17 @ up to 1.8 GHz
GPU	ARM Mali™-T764 MP4 @ 650MHz
Memory Size	Dual-CH LPDDR4 2GB/4GB
Storage	1 x Onboard 16GB eMMC* 1 x Micro SD card slot
Display	1 x HDMI (up to 4K/30Hz & CEC HW Ready) 1 x 15-pins MIPI DSI (2 lane) (HD)
Camera	1 x 15-pins MIPI CSI-2 (2 lane)
Connectivity	1 x RJ-45 GbE LAN 1 x Wi-Fi 802.11ac & BT 4.2 (2T2R, swappable antenna)
USB	4 x USB 2.0 Type-A
AUDIO	1 x HDMI audio out Realtek ALC4030U Codec with 1 x
Internal Headers	- 40-pin connector for GPIO (I2C, PWM, UART, SPI, I2S, etc) - DC fan header - RTC battery header - Power-On/Reset/Recovery/Debug headers
Power Connector	5V/2.5~3A Micro USB
OS Support	Debian 10 (32bit)/ Android 11 10 (32bit)
Dimension	85 x 56 mm



SPEC 비교 – Tinker Board R2.0 vs RPi 3B/3B+

Model	Tinker Board R2.0 Series	3B	3B+
Core Processor (SoC)	Rockchip RK3288-CG.W Quad-Core A17 1.8GHz	Broadcom BCM2837 Quad-Core A53 1.2GHz	Broadcom BCM2837B0 Quad-Core A53 1.4GHz
GPU	ARM Mali-T760 MP4 600MHz	Broadcom VideoCore IV 300MHz	Broadcom VideoCore IV 400MHz
RAM	2GB	1GB	1GB
Display Output Resolution	1 x HDMI@4K	1 x HDMI@1080P	1 x HDMI@1080P
4K Video Playback	Yes	No	No
System Storage	eMMC (S only) + SDIO 3.0	SDIO 2.0	SDIO 2.0
NIC	Gb LAN	100M LAN	Gb LAN (shared with USB 2)
Audio SPEC	1 x audio jack (with microphone) 1 x S/PDIF contact pin for extension 192K/24bit sampling rate	1 x audio jack (with Composite Video output)	1 x audio jack (with Composite Video output)
Wi-Fi	802.11 b/g/n	802.11 b/g/n	Dual-band 802.11 b/g/n/ac
Bluetooth	Yes, 4.2	Yes	Yes
Swappable Antenna for Better Signal	Yes, w/ swappable antenna	No	No
USB	4 x USB 2.0	4 x USB 2.0 (shared with LAN)	4 x USB 2.0 (shared with LAN)
Official Supported OS	Linux – Debian & Android 11	Linux – Debian	Linux – Debian

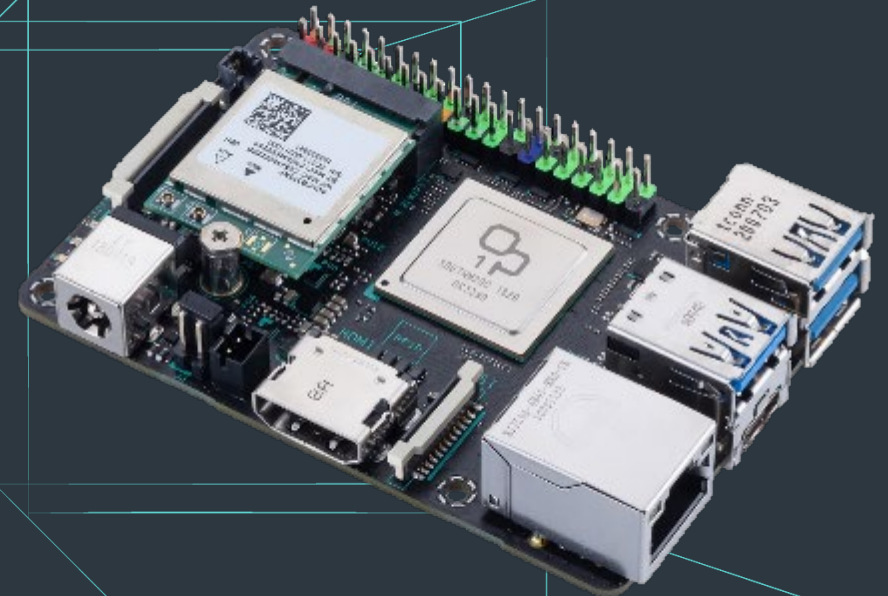
Key Summary

1. 확실히 더 나은 CPU/GPU 성능
2. 더 빠른 시스템 저장소 I/O 성능
3. 4K 출력 및 4K 재생 가능

4. 더 나은 오디오 퀄리티
5. 변경 가능한 안테나를 통한 더 나은 무선 신호
6. 엄청난 기술적, 기업적 지원

Tinker Board 2 series - 사양

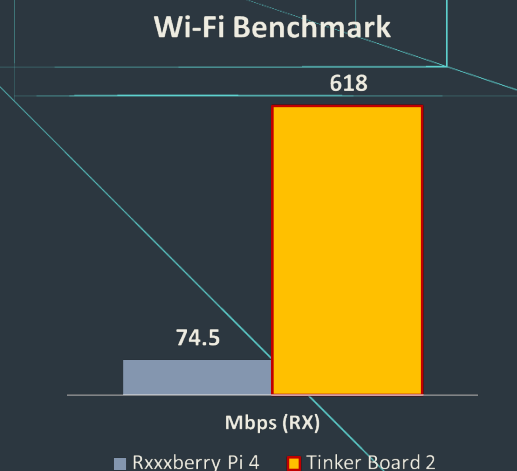
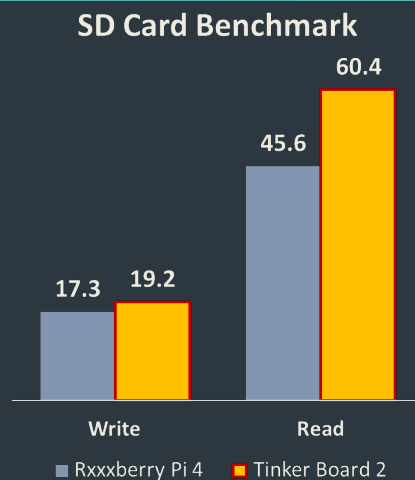
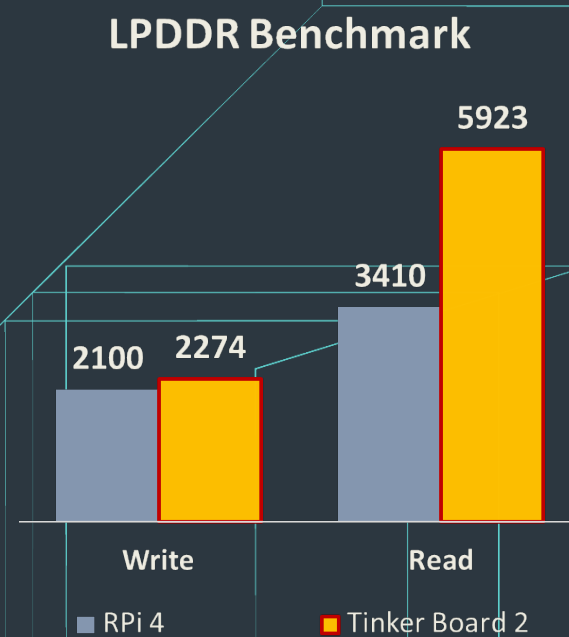
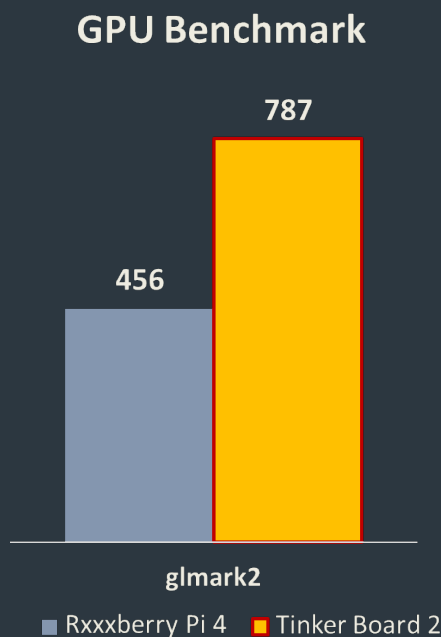
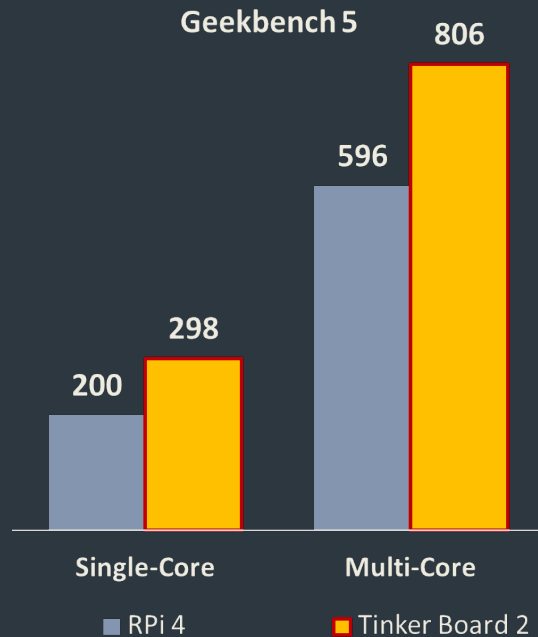
	TINKER BOARD 2 / TINKER BOARD 2S
SoC	Rockchip RK3399 (64-bit)
CPU	Dual-core ARM Cortex-A72 @ 2.0GHz + Quad-core ARM Cortex-A53 @ 1.5GHz
GPU	ARM Mali-T860 MP4 @ 800MHz
Memory Size	Dual-CH LPDDR4 2GB/4GB
Storage	1 x Onboard 16GB eMMC* 1 x Micro SD card slot
Display	1 x HDMI 2.0 (up to 4K/60Hz & CEC HW Ready) 1 x Type-C (DP 1.2 Alt Mode) 1 x 22-pins MIPI DSI (4 lanes)
Camera	1 x 15-pins MIPI CSI-2 (2 lane)
Connectivity	1 x RJ-45 GbE LAN 1 x Wi-Fi 802.11ac & BT 5.0 (2T2R, swappable antenna)
USB	3 x USB 3.2 Gen1 Type-A 1 x USB 3.2 Gen1 Type-C OTG
Internal Headers	- 40-pin connector for GPIO (I2C, PWM, UART, SPI, I2S, etc) - DC fan header - RTC battery header - Power-On/Reset/Recovery/Debug headers
Power Connector	12V~19V DC-in (Barrel jack 5.5Ø/2.5Ø)
OS Support	Debian 10 / Android 11
Dimension	85 x 56 mm



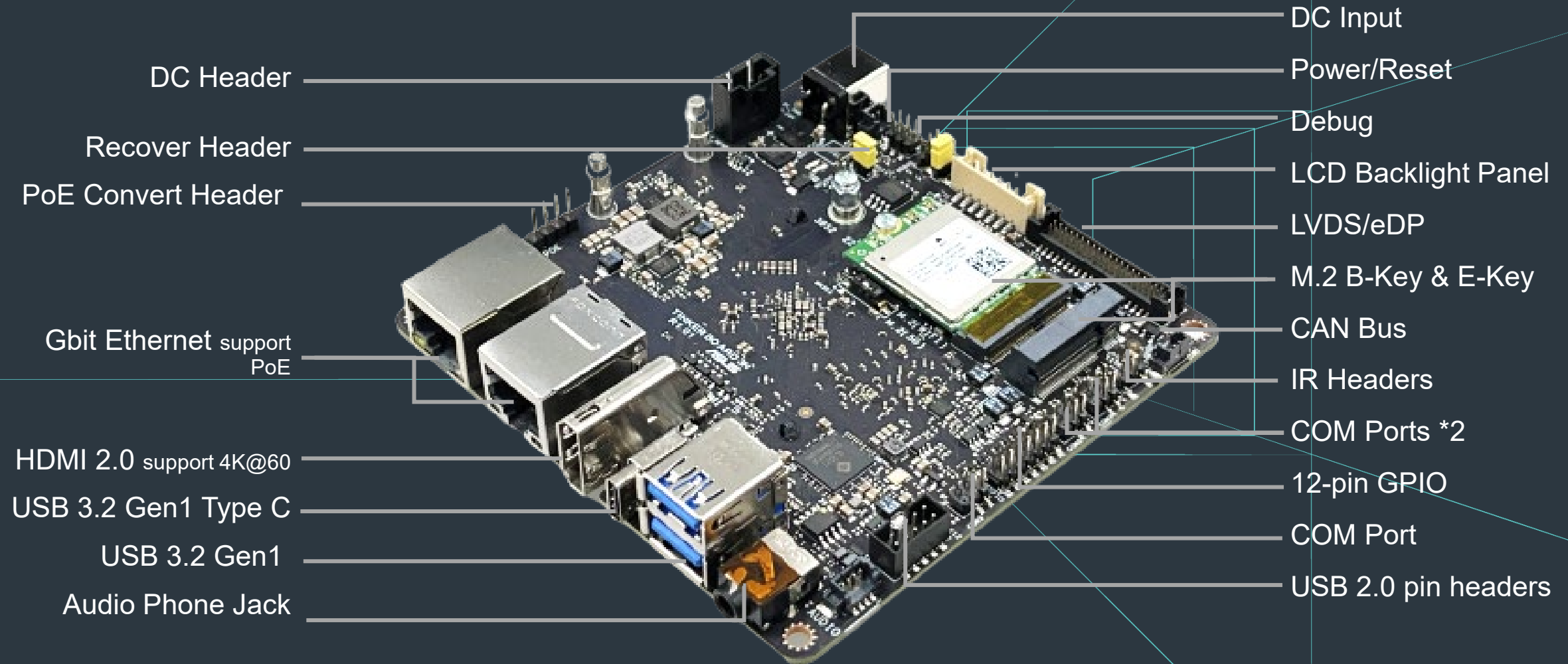
SPEC 비교 – Tinker Board 2 vs RPi 4

Model	Tinker Board 2 Series	Rxxxberry Pi 4 Model B
Core Processor (SoC)	Rockchip RK3399 (64-bit) Dual-core ARM Cortex-A72 @ 2.0GHz + Quad-core ARM Cortex-A53 @ 1.5GHz	Broadcom BCM2711 Quad-core ARM Cortex-A72 1.5GHz
GPU	ARM Mali-T860 MP4 @ 800MHz	Broadcom VideoCore VI 500MHz
RAM	Dual-CH LPDDR4 2GB/4GB	Single-CH LPDDR4 2GB / 4GB / 8GB
Display	1 x HDMI 2.0 (up to 4K/60Hz & CEC HW Ready) 1 x Type-C (DP 1.2 Alt Mode) 1 x 22-pins MIPI DSI (4 lane) 1 x 15-pin MIPI CSI-2 (2 lane)	2 x Micro HDMI (up to 4K/60Hz) 1 x 15-pins MIPI DSI display port (2-lane) 1 x 15-pin MIPI CSI camera port (2-lane)
System Storage	1 x Onboard 16GB eMMC (S only) 1 x Micro SD card slot	1 x Micro SD card slot
Internal Headers	40-pin connector for GPIO (I2C, PWM, UART, SPI, I2S, etc) DC fan header RTC battery header Power-On/Reset/Recovery/Debug headers	40-pin GPIO header
Wi-Fi	1 x Wi-Fi 802.11 a/b/g/n/ac & BT 5.0 (2T2R)	1 x Wi-Fi 802.11b/g/n/ac & BT 5.0 (1T1R)
Swappable Antenna for Better Signal	Yes, w/ swappable antenna	No
USB	3 x USB 3.2 Gen1 Type-A 1 x USB 3.2 Gen1 Type-C OTG	2 x USB 3.0 ports 2 x USB 2.0 ports
Official Supported OS	Debian 11 / Android 11	Linux – Debian 10

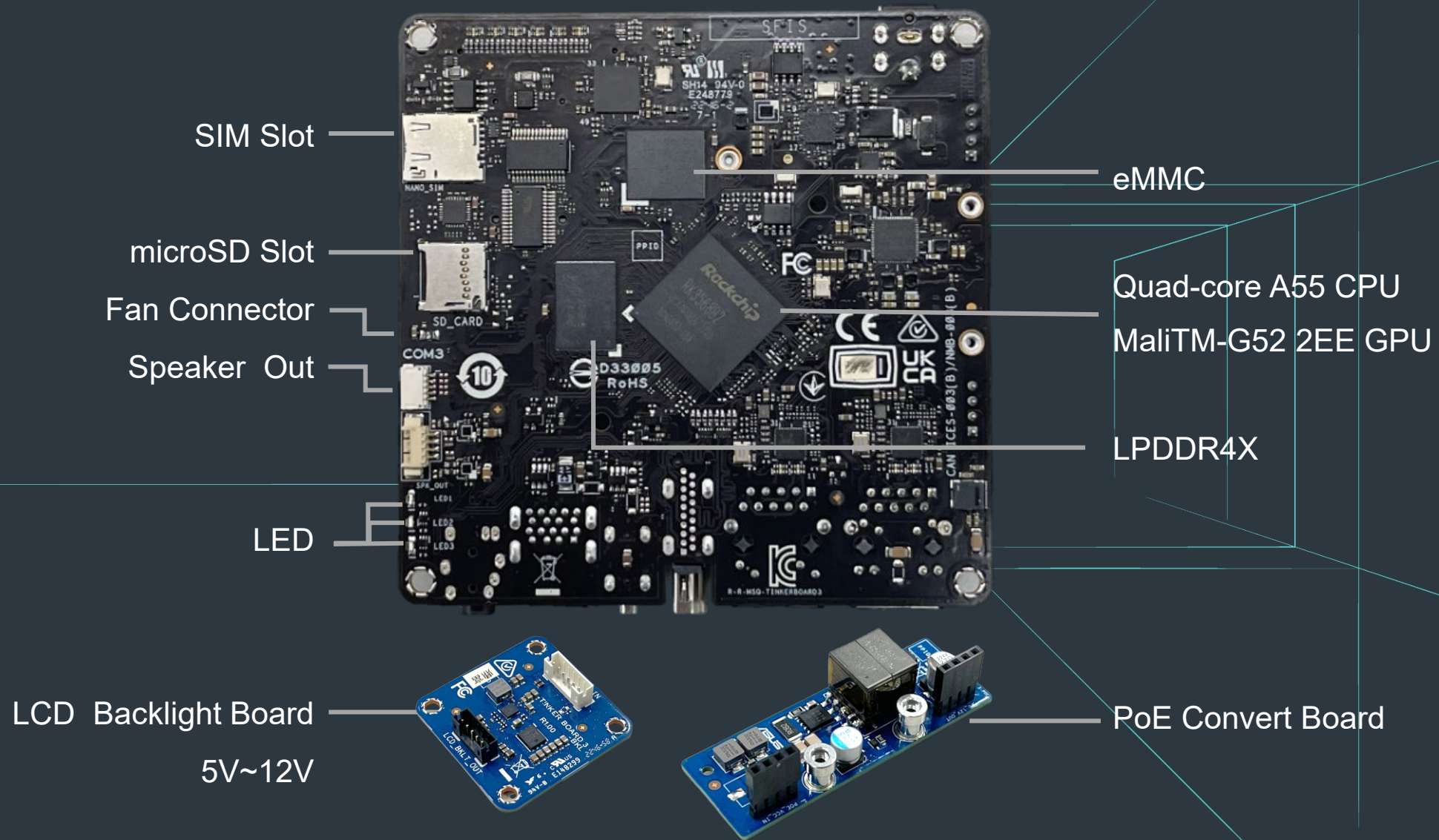
Benchmark 비교 – Tinker Board 2 vs RPi 4



Tinker Board 3N series – 9월 런칭



Tinker Board 3N series – Overview



SKU and Naming Rule

Type	Details	Ram size	eMMC size
TINKER BOARD 3N PLUS	Wide Temp. Full Spec	/2G	/32G
TINKER BOARD 3N	Standard Temp. Full Spec	/4G	/64G
TINKER BOARD 3N LITE	Standard Temp. Lite Spec	/8G	

e.g.

TINKER BOARD 3N PLUS/4G/32G

TINKER BOARD 3N/4G/32G

TINKER BOARD 3N LITE/4G/32G

TINKER BOARD 3N PLUS/4G

TINKER BOARD 3N/4G

TINKER BOARD 3N LITE/4G

Optional Spec	SPI Flash	LAN	M.2 B-Key	CAN	COM 232 (w/ Flow Ctrl.)
Full	16MB	2	1	1	2
Lite	n/a	1	n/a	n/a	1

Tinker Board 3N PLUS Specification

SoC	Rockchip RK3568
CPU	Quad-core Arm® Cortex®-A55
GPU	Arm® Mali™-G52
Display	1 x HDMI™ with CEC hardware ready , up to 4096 x 2160 @ 60 Hz 1 x LVDS (Dual-link) up to 1920 x 1080 @60 Hz + eDP up to 2560 x 1600 @ 60 H
Memory Size	Dual-CH LPDDR4/LPDDR4X 2GB / 4GB
Storage	none / 32GB / 64GB eMMC
	Micro SD(TF) card slot (push/pull)
	SPI Flash 16MB
Ethernet	2 x RTL8211 GbE LAN
POE Power-In	x1 (one LAN support POE via module card, 802.3at 25W)
M.2 E-Key 2032	x1 for Wi-Fi / BT module* (PCIe 2.0x1, USB 2.0)
M.2 B-Key 3042/3052	x1 for 4G / 5G / SSD module (PCIe 3.0x1, USB 3.0, USB 2.0, SIM)
Audio	1 x 3.5 Phone Jack (w/ Mic)
	1 x Speaker Out, Stereo Pin Header (4ohm, 3W each)
USB	1 x USB 3.2 Gen1 Type-C® OTG port
	2 x USB 3.2 Gen1 Type-A ports
	2 x USB 2.0 Pin header
CAN Bus	x1 Pin Header
COM 232	x2 Pin Header with flow control
COM 232/422/485	x1 Pin Header
Internal Headers	1 x 40-pin LVDS + eDP connector
	1 x 5V Panel Backlight & Control header
	1 x 12-pin GPIO headers includes (up to 4 x PWM, up to 1 x SPDIF, up to 1 x SPI with 2 CS, 1 I2C, 1 UART, 1 GND, 2 ADC 8bit)
Power Connector 12~24V	1 x DC Barrel Power Input Jack (5.5/2.5 mm)
	1 x 4-Pin Power In Header (also for POE module)
Operating Temperature	-40°C ~ 85°C
OS Support	Debian 11 / Android 12/ Yocto
Dimension	4 x 4 inches / 100 x 100 mm

Tinker Board 3N Specification

SoC	Rockchip RK3568
CPU	Quad-core Arm® Cortex®-A55
GPU	Arm® Mali™-G52
Display	1 x HDMI™ with CEC hardware ready , up to 4096 x 2160 @ 60 Hz 1 x LVDS (Dual-link) up to 1920 x 1080 @60 Hz + eDP up to 2560 x 1600 @ 60 H
Memory Size	Dual-CH LPDDR4/LPDDR4X 2GB / 4GB / 8GB
Storage	none / 32GB / 64GB eMMC
	Micro SD(TF) card slot (push/pull)
	SPI Flash 16MB
Ethernet	2 x RTL8211 GbE LAN
POE Power-In	x1 (one LAN support POE via module card, 802.3at 25W)
M.2 E-Key 2032	x1 for Wi-Fi / BT module* (PCIe 2.0x1, USB 2.0)
M.2 B-Key 3042/3052	x1 for 4G / 5G / SSD module (PCIe 3.0x1, USB 3.0, USB 2.0, SIM)
Audio	1 x 3.5 Phone Jack (w/ Mic)
	1 x Speaker Out, Stereo Pin Header (4ohm, 3W each)
USB	1 x USB 3.2 Gen1 Type-C® OTG port
	2 x USB 3.2 Gen1 Type-A ports
	2 x USB 2.0 Pin header
CAN Bus	x1 Pin Header
COM 232	x2 Pin Header with flow control
COM 232/422/485	x1 Pin Header
Internal Headers	1 x 40-pin LVDS + eDP connector
	1 x 5V Panel Backlight & Control header
	1 x 12-pin GPIO headers includes (up to 4 x PWM, up to 1 x SPDIF, up to 1 x SPI with 2 CS, 1 I2C, 1 UART, 1 GND, 2 ADC 8bit)
Power Connector 12~24V	1 x DC Barrel Power Input Jack (5.5/2.5 mm)
	1 x 4-Pin Power In Header (also for POE module)
Operating Temperature	0°C ~ 60°C
OS Support	Debian 11 / Android 12/ Yocto
Dimension	4 x 4 inches / 100 x 100 mm

Tinker Board 3N LITE Specification

SoC	Rockchip RK3568
CPU	Quad-core Arm® Cortex®-A55
GPU	Arm® Mali™-G52
Display	1 x HDMI™ with CEC hardware ready , up to 4096 x 2160 @ 60 Hz 1 x LVDS (Dual-link) up to 1920 x 1080 @60 Hz + eDP up to 2560 x 1600 @ 60 H
Memory Size	Dual-CH LPDDR4/LPDDR4X 2GB / 4GB / 8GB
Storage	none / 32GB / 64GB eMMC Micro SD(TF) card slot (push/pull)
Ethernet	1 or 2 x RTL8211 GbE LAN (optional)
M.2 E-Key 2032	x1 for Wi-Fi / BT module* (PCIe 2.0x1, USB 2.0)
Audio	1 x 3.5 Phone Jack (w/ Mic) 1 x Speaker Out, Stereo Pin Header (4ohm, 3W each)
USB	1 x USB 3.2 Gen1 Type-C® OTG port 2 x USB 3.2 Gen1 Type-A ports 2 x USB 2.0 Pin header
COM 232/422/485	x1 Pin Header
Internal Headers	1 x 4-pin Power-on & Reset header 1 x 2-pin Maskrom (eMMC recovery) header 1 x IR Receiver header / 1 x 3-pin Debug UART header 1 x 4-pin DC Fan header / 1 x 2-pin RTC Battery header
Power Connector 12~24V	1 x DC Barrel Power Input Jack (5.5/2.5 mm) 1 x 4-Pin Power In Header (also for POE module)
OS Support	Debian 11 / Android 12/ Yocto
Dimension	4 x 4 inches / 100 x 100 mm

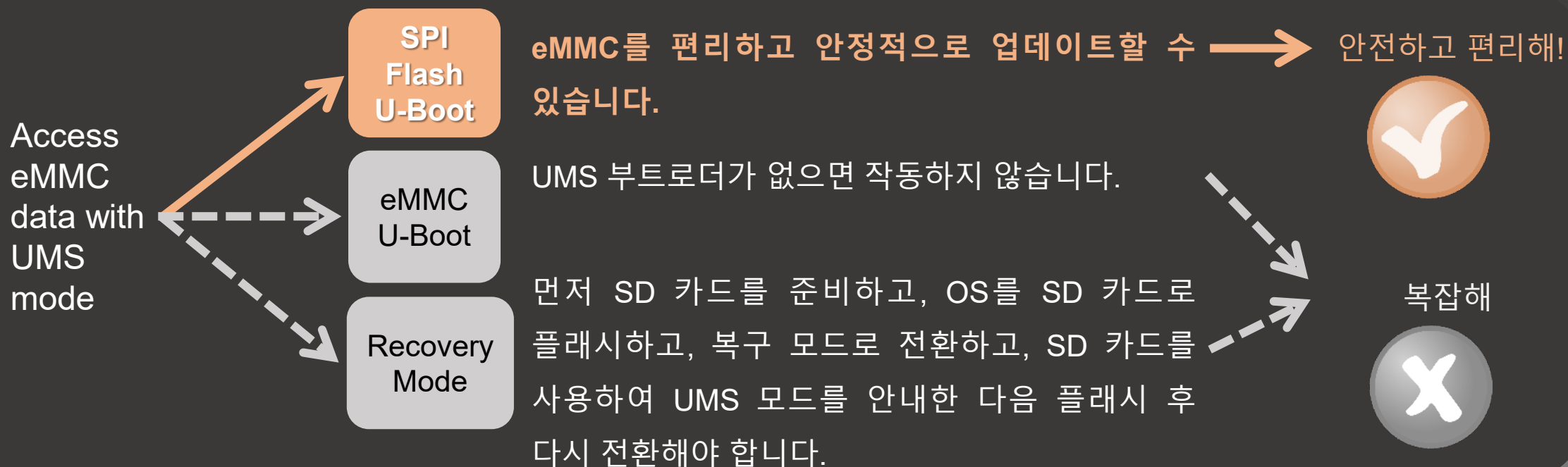
Tinker Board 3N Series 차이점

SKU Type		3N PLUS	3N	3N LITE	
Memory	Size*	2GB / 4GB	2GB / 4GB / 8GB		
Storage	eMMC*	none / 32GB / 64GB			
	SPI Flash	16MB		n/a	
Ethernet	Controller	2 x Realtek RTL8211		1 x Realtek RTL8211	
	POE PD	1 x one LAN support POE via module card			n/a
Expansion	M.2 B key 3042/3052	1 x for 4G/5G/SSD (PCIe 3.0 x1, USB 3.0, USB 2.0, SIM)			n/a
Serial Interface	CAN Bus 2.0B FD	1 x 3-Pin header			n/a
	COM RS232 (w/ flow control)	2 x 5-Pin header			n/a
Internal Header	Maskrom (SPI Flash)	1 x 2-pin header			n/a
Environment	Operating Temperature	-40 ~ 85°C		0 ~ 60°C	

SPI Flash U-Boot를 이용한 CrashFree UMS 모드

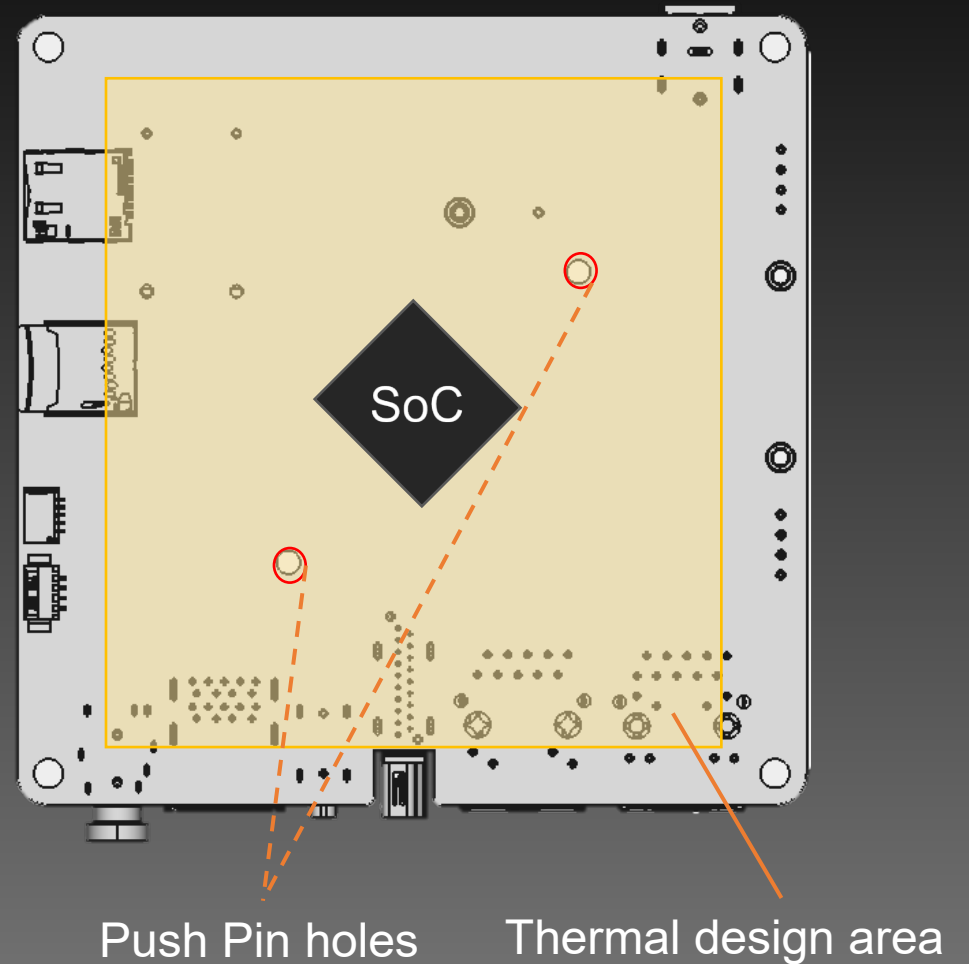
UMS 모드*는 온보드 eMMC에 직접 OS를 편리하게 배포할 수 있지만 UMS 부트로더가 없으면 사용할 수 없으므로 OS 설치 프로세스가 다시 복잡해집니다. CrashFree UMS 모드는 온보드 eMMC와 독립적으로 작동하며, UMS 부트로더가 손상되는 경우가 드물지만 OS 복구의 필요성을 완화하면서 동일한 수준의 편의성을 제공합니다.

**UMS (USB Mass Storage) 모드는 PC 연결을 기기의 메모리를 USB 메모리처럼 인식하게 합니다.



Stable Thermal Design

- LP 타입의 푸쉬핀 방열판
- 뒷면에 SoC를 배치하여 유연성을 제공
시스템 통합을 위한 열 설계 옵션
- 더 넓은 온도 지원을 가능케 함
- 다양한 도전적인 환경에 적합:
 - Down to -40°C .
 - Factory or environment with high temp
temperature under 85°C .



다중 디스플레이 솔루션

- 메인스트림 패널 사양에 적합한 듀얼 채널을 통한 풀 HD 출력이 가능한 LVDS 온보드
- 패널 백라이트 전원 핀을 제공하여 패널을 쉽게 통합

All Configs		1st Display	
		HDMI 4096x2160@60	eDP 2560x1600@60
2nd Display	HDMI 1920x1080@60	-	V
	eDP 1920x1080@60	V	-
	LVDS 1920x1080@60	V	-



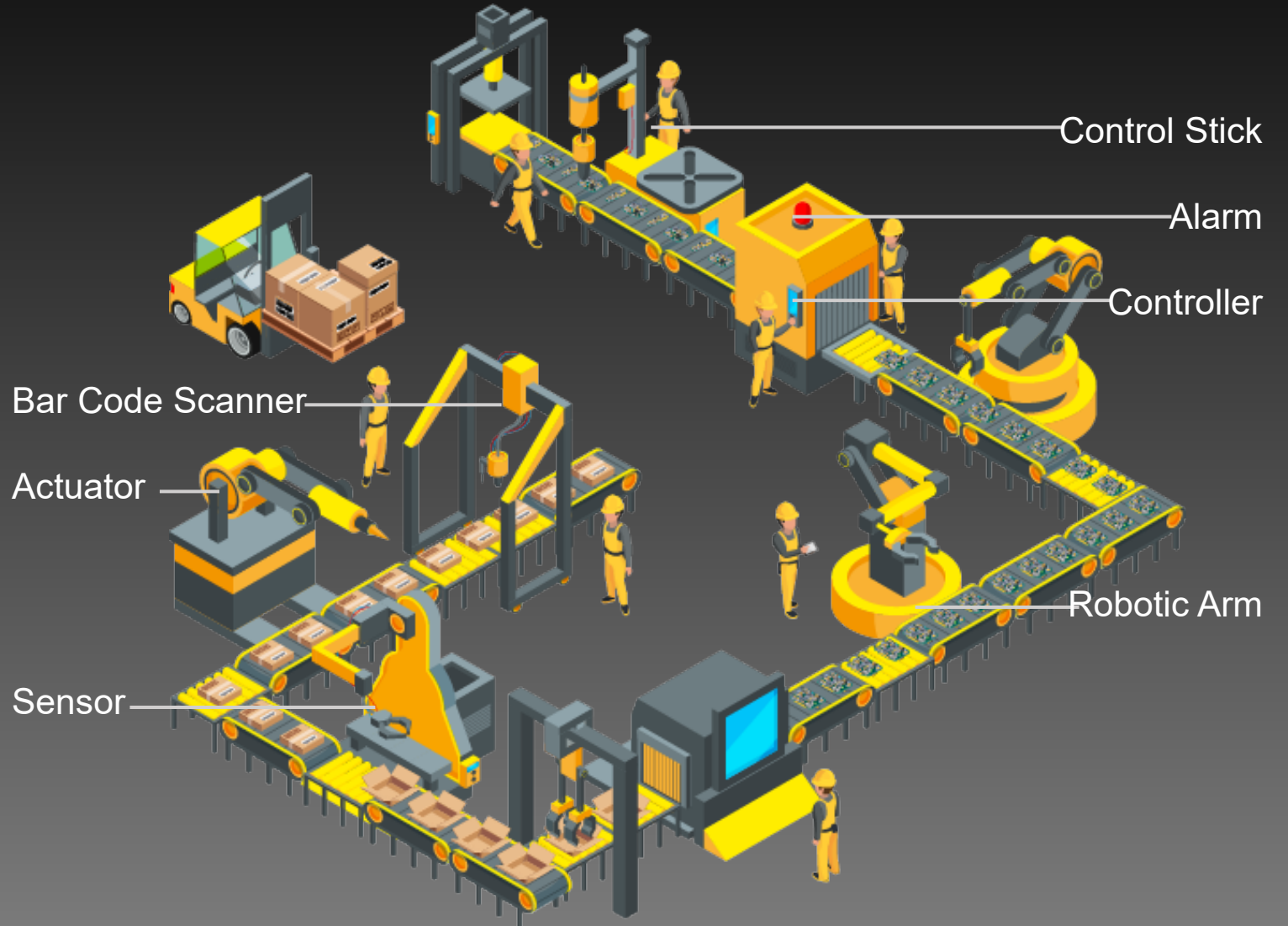
Suitable for multiple display use in various embedded design.

산업용 솔루션을 위한 확장성

COM headers 와 CAN Bus는

다양한 어플리케이션에 적합함

- COM RS-232 x2 Pin Header.
- COM RS-232/422/485 x1 Pin Header.
- CAN Bus x1 Pin Header.

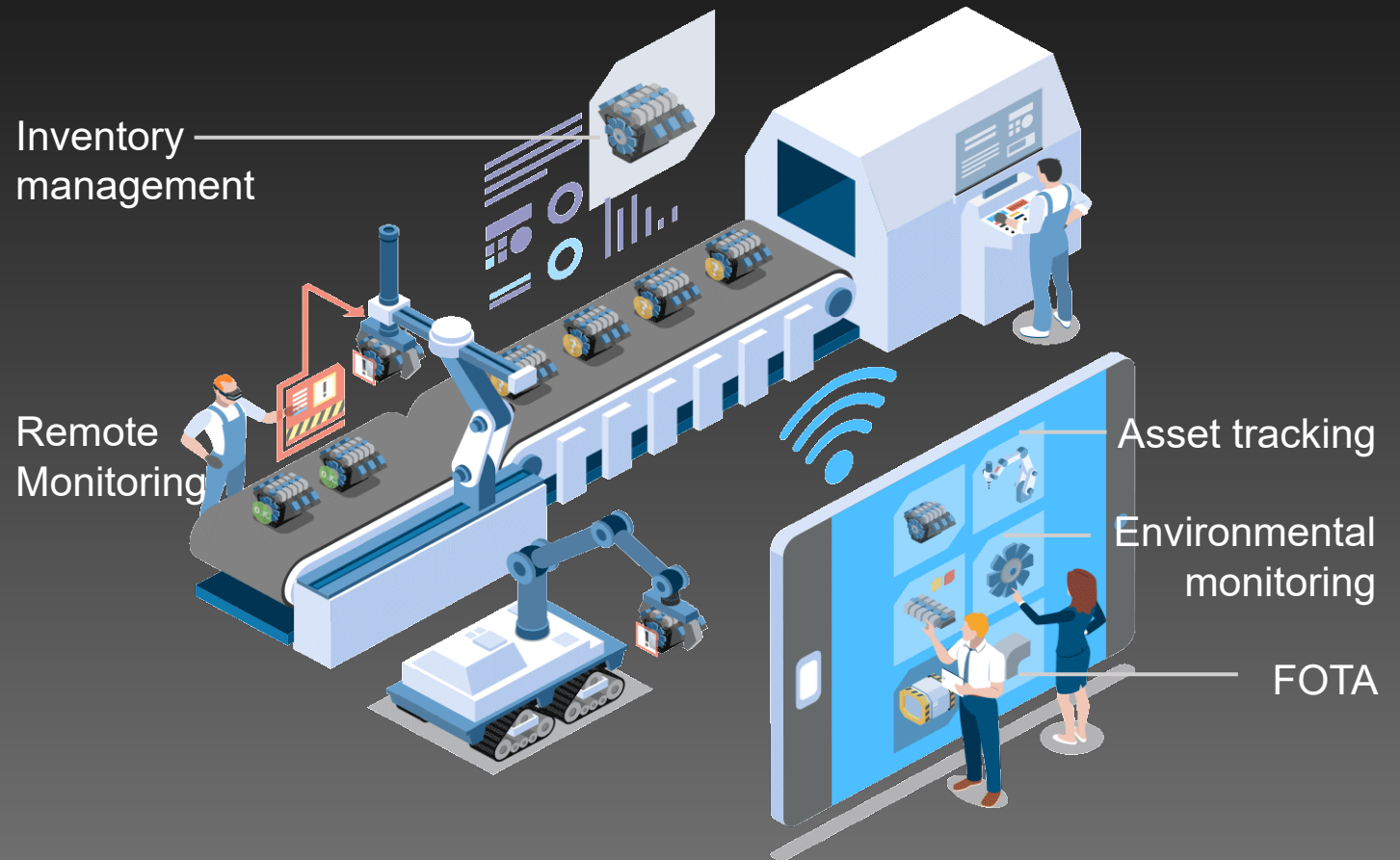


산업용 솔루션을 위한 확장성

다른 장치 및 네트워크와의

안정적인 통신

- M.2 E-Key 2032는 Wi-Fi / BT 확장을 가능케 함.
- M.2 B-Key 3042/3052는 4G / 5G modules 및 SSD 기능을 가능케 함.

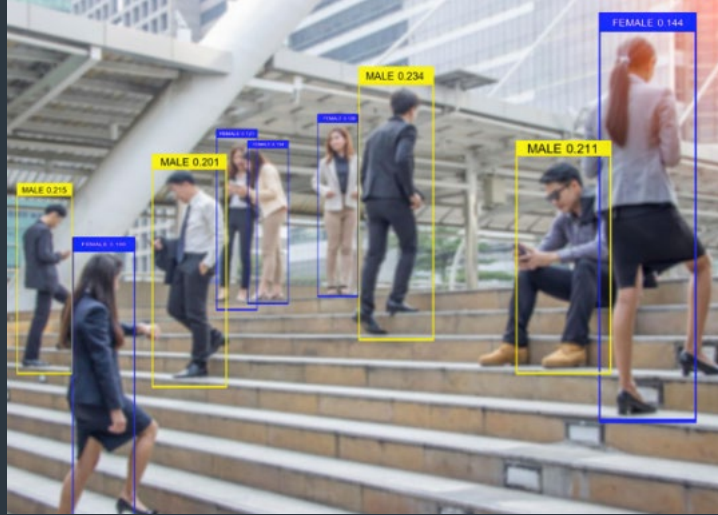


Supportive OS assistance

Tinker Board 3N provides a variety of the latest and mainstream operating system platforms to use in different area. With official OS supports, ASUS would keep maintain and midgrade to latest mainstream OS version based on the SoC vender roadmap, in product life cycle.



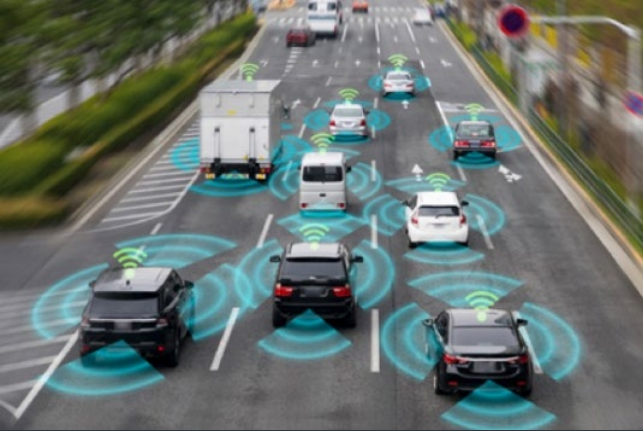
Industry Application - Smart Cities



스마트 시티

- 차량 보행자 감지
- 인구 밀도/흐름 모니터링 및 분석
- 공기 질 모니터링 및 분석
- 인프라 데이터 관제 센터

Industry Application - TRANSPORT & LOGISTICS



교통 & 물류

- 교통 흐름 데이터 분석
- 교통 운행 관리
- 재고 컨트롤
- 배송 패키지 추적

Industry Application - RETAIL



소매업

- 진열대/입구에서의 고객 안면 인식
- 고객들 사이에 사회적 거리두기 인식
- 물체 인식을 통한 무인 계산
- ASUS IoT Cyber Security



Industry Application - HEALTHCARE



헬스케어

- 환자 질병 데이터 모니터링
- 패턴 분석을 통한 질병 인지 및 예측
- 의약품 보조 케어
- 약물 원격 처방/구매

Case Sharing – Tinker Board S -> 주차 정산기



왜 텀커를 써야할까?

- 낮은 비용으로 고성능의 키오스크 제작 가능
- X86기반 시스템에 비해 낮은 전력소모
- 컴팩트한 클라우드 기반 솔루션

More accessories

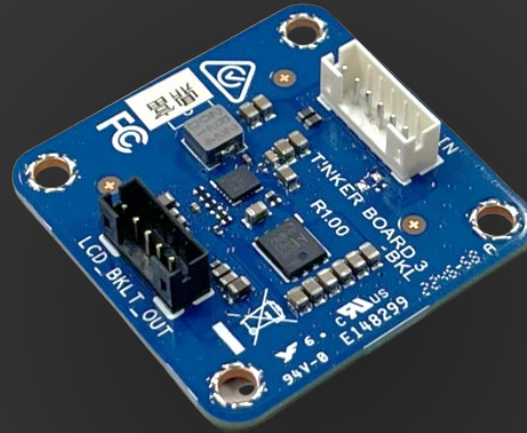
- Adapter



- 65W DC (5.5/2.5) adapter

*Picture for reference only, may depending on region or specs.

- Backlight Module



- Backlight module for LVDS

- PoE Module



- Power over Ethernet module